CLAIMS

- 1. A bipolar transistor, comprising:
- a first semiconductor region of a first conductivity type defining a collector region;
- a second semiconductor region of a second conductivity type defining a base region;
- a third semiconductor region of said first conductivity type defining a emitter region; and

a metal layer providing contacts to said base and emitter regions;

wherein the transistor has a specific area resistance less than about 500mOhms.mm²; and

wherein said metal layer has a thickness greater than about 3 µm.

- 2. A bipolar transistor according to claim 1, wherein the metal layer has a thickness no less than 4µm.
- 3. A bipolar transistor according to any preceding claim, wherein the metal layer has a thickness no less than 6µm.
- 4. A bipolar transistor according to any preceding claim, wherein the emitter region defines a first surface, the base region extending to said surface in locations defined by apertures through emitter region, said metal layer overlying said first surface.
- 5. A bipolar transistor according to claim 4, wherein adjacent apertures are spaced less than 100 µm from each other.
- 6. A bipolar transistor substantially as hereinbefore defined, with reference to the accompanying drawing.